

#### N-Ch 100V Fast Switching MOSFET VDS=100V, ID=60A ,RDS(ON)=12mΩ

# General Description

This PAN00TF24GF N-Channel enhancement mode power field effect transistor is the high density trench technology and this advanced technology can provide excellent Rds(On) performance and efficiency for power switching and load switching application., this device also comply with the RoHS and Green Product requirement with full function reliability approved.

# Feature

- Super Low Gate Charge
- 100% EAS Guaranteed
- Green Device Available
- Excellent Cdv /dt effect decline
- Advanced high cell density Trenchtechnology

# > <u>Application</u>

- SMPS Power Supplier
- Charger Adapter
- Power Tools
- LED Lighting

# G S S

TO220F

# Absolute Maximum Ratings

Parameter	Symbol	Rating	Units
Drain-Source Voltage	Vds	100	V
Gate-Source Voltage	Vgs	±20	V
Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	ID@Tc=25°C	60	A
Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	ID@Tc=100°C	43	A
Pulsed Drain Current <sup>2</sup>	I <sub>DM</sub>	250	A
Single Pulse Avalanche Energy <sup>3</sup>	EAS	180	mJ
Avalanche Current	las	60	A
Total Power Dissipation <sup>4</sup>	P <sub>D</sub> @T <sub>C</sub> =25℃	40	W
Storage Temperature Range	Tstg	-55 to 175	°C
Operating Junction Temperature Range	TJ	-55 to 175	°C
Thermal Resistance Junction-Ambient <sup>1</sup>	Reja	62	°C/W
Thermal Resistance Junction-Case <sup>1</sup>	Rejc	3.7	°C/W





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## Electrical Characteristics (TJ=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	100			V
Static Drain-Source On-Resistance <sup>2</sup>	Rds(on)	V <sub>GS</sub> =10V , I <sub>D</sub> =15A		9	12	mΩ
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	2.5		4.5	V
Drain-Source Leakage Current	IDSS	$V_{DS}$ =80V , $V_{GS}$ =0V , $T_J$ =25°C			1 uA	
	IDSS	$V_{DS}$ =80V , $V_{GS}$ =0V , $T_{J}$ =55°C			5	
Gate-Source Leakage Current	lgss	$V_{GS}=\pm 20V$ , $V_{DS}=0V$			±100	nA
Forward Transconductance	gfs	V <sub>DS</sub> =5V , I <sub>D</sub> =30A		50		S
Gate Resistance	Rg	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		1.2		Ω
Total Gate Charge (10V)	Qg			84		
Gate-Source Charge	Qgs	VDS=80V, VGS=10V, ID=30A		28		nC
Gate-Drain Charge	Qgd			26		
Turn-On Delay Time	Td(on)			36		
Rise Time	Tr	VDD=40V, VGS=10V, RG= $3.3\Omega$ ,		71		ns
Turn-Off Delay Time	Td(off)	ID=30A		50		1
Fall Time	Tf			23		
Input Capacitance	Ciss			5580		
Output Capacitance	Coss	VDS=15V , VGS=0V , f=1MHz		571		pF
Reverse Transfer Capacitance	Crss			278		1

# Diode Characteristics

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Continuous Source Current <sup>1,5</sup>	ls	$V_G=V_D=0V$ , Force Current			60	А
Diode Forward Voltage <sup>2</sup>	V <sub>SD</sub>	Vgs=0V , Is=A , Tj=25°C			1.2	V
Reverse Recovery Time	trr	IF=30A , dI/dt=100A/µs ,		24		nS
Reverse Recovery Charge	Qrr	TJ=25°C		28		nC

Note :

1.Pulse width limited by maximum junction temperature.

2.The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%

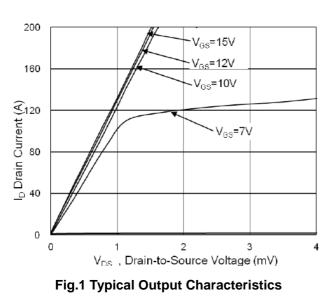
3.The EAS data shows Max. rating . The test condition is  $V_{\text{DD}}\text{=}25V, V_{\text{GS}}\text{=}10V, L\text{=}0.1\text{mH}, I_{\text{AS}}\text{=}60\text{A}$ 

4.Ensure that the channel temperature does not exceed 150°C.

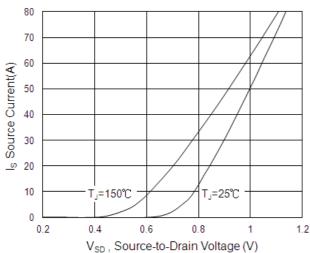
5. The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.



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**Typical Characteristics** 



**Fig.3 Source Drain Forward Characteristics** 

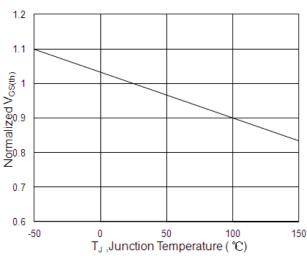


Fig.5 Normalized V<sub>GS(th)</sub> vs. T<sub>J</sub>

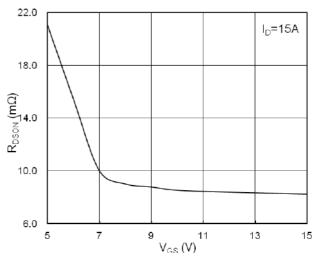


Fig.2 On-Resistance vs. G-S Voltage

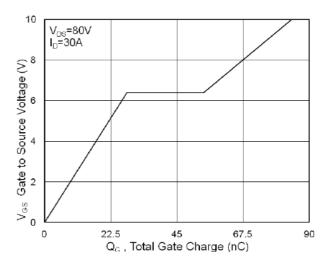


Fig.4 Gate-Charge Characteristics

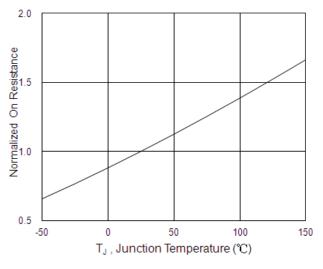
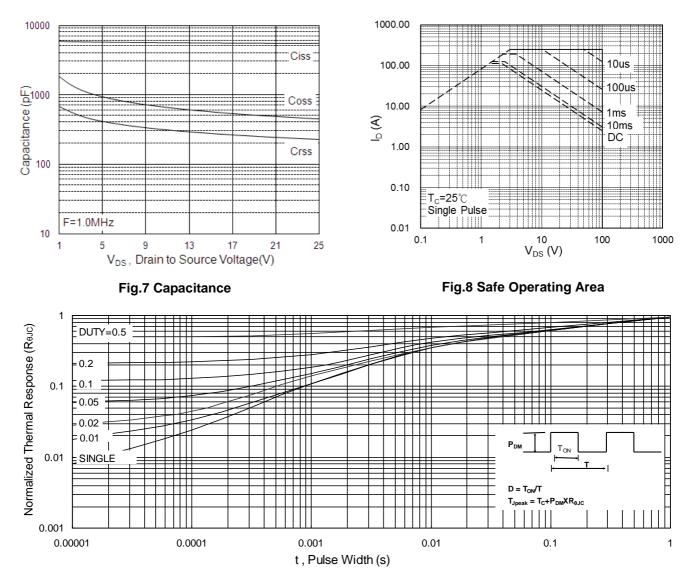


Fig.6 Normalized RDSON vs. TJ



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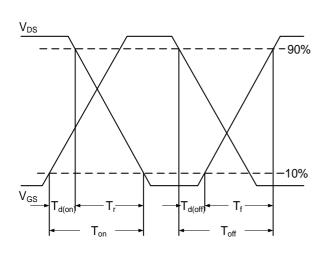
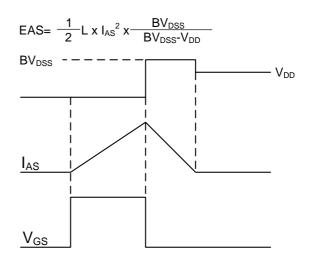


Fig.10 Switching Time Waveform



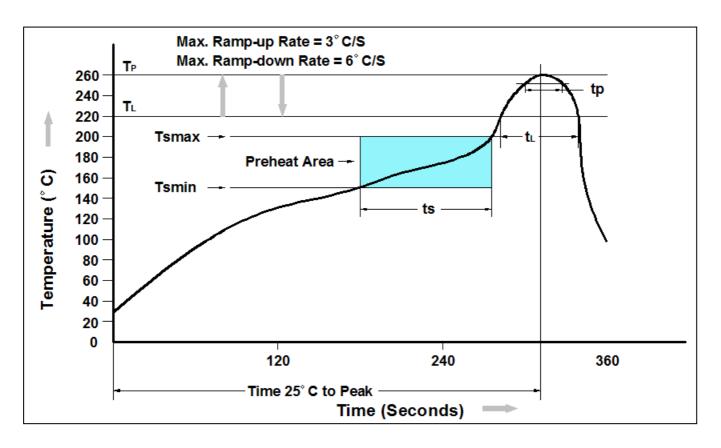
#### Fig.11 Unclamped Inductive Switching Waveform



# N-Ch 100V Fast Switching MOSFET

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### <u>Recommand IR Reflow Soldering Thermal Profile</u>



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Average Ramp-up Rate (tL to tP)	3°C/second max.
Liquidous Temperature (TL)	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds
Peak Temperature	260°C +0°C / -5°C
Time (tP) within 5°C of actual Peak Temperature	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.

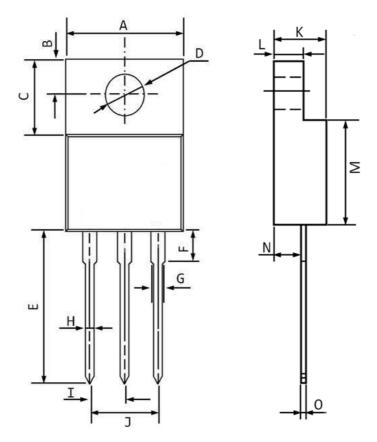
# Ordering Information

Part Number	Description	Quantity
PAN00TF24GF	TO-220F / 50 pcs/tube	1000 pcs



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# Package Information (TO-220F)



SYMBOLS	MILLIMETERS		INCHES	
	Min.	Max.	Min.	Max.
Α		10.50		0.414
В	2.60	3.00	0.102	0.118
С	6.70	7.10	0.264	0.280
D	2.90	3.50	0.114	0.138
E	13.10	13.90	0.516	0.548
F		4.00		0.158
G	1.11	1.45	0.044	0.057
Н	0.40	0.80	0.016	0.032
I	2.40	2.80	0.095	0.110
J	5.00	5.40	0.197	0.213
К	4.30	4.70	0.169	0.185
L	2.90	3.30	0.114	0.130
М	8.20	9.00	0.323	0.355
N	2.50	2.90	0.099	0.114
0	0.40	0.80	0.016	0.032



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